

D-SUB power contact - VS-BU-LH-3,6/18/3,8 - 1655454

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POWER contact, for D-SUB combination inserts, for PCB assembly, socket, angled, rated current 40 A, gold-plated



Key Commercial Data

Packing unit	30 STK
Minimum order quantity	30 STK
GTIN	 4 046356 029384
GTIN	4046356029384
Weight per Piece (excluding packing)	2.500 g
Custom tariff number	85366990
Country of origin	Germany

Technical data

Mechanical characteristics

Insertion/withdrawal cycles	≥ 500
Connection method	PCB mounting
Type of contact	Socket
Insertion force per signal contact	≤ 7.00 N
Extraction force per signal contact	approx. 5 N
Insulation resistance	≥ 5 GΩ
Contact type	turned

Ambient conditions

Ambient temperature (operation)	-55 °C ... 155 °C
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Material data

Contact material	Copper alloy
Contact surface material	Hard gold-plated over nickel

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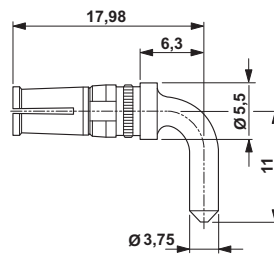
Technical data

Electrical characteristics

Rated current	40 A
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Drawings

Dimensional drawing



D-SUB power contact socket

Classifications

eCl@ss

eCl@ss 4.0	27140816
eCl@ss 4.1	27260701
eCl@ss 5.0	27260701
eCl@ss 5.1	27260701
eCl@ss 6.0	27261202
eCl@ss 7.0	27440204
eCl@ss 8.0	27440204
eCl@ss 9.0	27440204

ETIM

ETIM 2.0	EC000796
ETIM 3.0	EC000796
ETIM 4.0	EC000796
ETIM 5.0	EC000796

UNSPSC

UNSPSC 6.01	30211923
UNSPSC 7.0901	39121522
UNSPSC 11	39121522
UNSPSC 12.01	39121522
UNSPSC 13.2	39121522

Approvals

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Approvals

Approvals

EAC / EAC

Ex Approvals

Approval details

EAC 7500651.22.01.00246

EAC B.01742

Accessories

Accessories

Assembly tool

Contact removal tool - HC-M4-KOAX-EWZ - 1676747



Contact removal tool for coaxial contacts
